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Description

The Atmel® ATWILC3000 is a single chip IEEE® 802.11 b/g/n RF/Baseband/MAC link controller and Bluetooth® 4.0 optimized for low-power mobile applications. The ATWILC3000 supports single stream 1x1 802.11n mode providing up to 72Mbps PHY rate. The ATWILC3000 features fully integrated Power Amplifier, LNA, Switch, and Power Management. Implemented in 65nm CMOS technology, the ATWILC3000 offers very low power consumption while simultaneously providing high performance and minimal bill of materials.

The ATWILC3000 utilizes highly optimized 802.11-Bluetooth coexistence protocols. The ATWILC3000 provides multiple peripheral interfaces including UART, SPI, I²C, and SDIO. The only external clock sources needed for the ATWILC3000 is a high-speed crystal or oscillator with a wide range of reference clock frequencies supported (14-40MHz) and a 32.768kHz clock for sleep operation. The ATWILC3000 is available in both QFN and Wafer Level Chip Scale Package (WLCSP) packaging.

Features

- IEEE 802.11 b/g/n 20MHz (1x1) solution
- Single spatial stream in 2.4GHz ISM band
- Integrated PA and T/R Switch
- Superior Sensitivity and Range via advanced PHY signal processing
- Advanced Equalization and Channel Estimation
- Advanced Carrier and Timing Synchronization
- Wi-Fi Direct and Soft-AP support
- Supports IEEE 802.11 WEP, WPA, and WPA2 Security
- Supports China WAPI security
- Superior MAC throughput via hardware accelerated two-level A-MSDU/A-MPDU frame aggregation and block acknowledgement
- On-chip memory management engine to reduce host load
- SPI, SDIO, I²C, and UART host interfaces
- Operating temperature range of -40°C to +85°C

Bluetooth:

- Bluetooth 4.0 (Basic Rate, Enhanced Rate and BLE)
- Class 1 and 2 transmission
- Adaptive Frequency Hopping
- HCI (Host Control Interface) via high speed UART
- Integrated PA and T/R Switch
- Superior Sensitivity and Range
- PCM audio interface

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Atmel

Table of Contents

1   Ordering Information and IC Marking

Table 1-1.   Ordering Details

Atmel Official Part Number (for ordering)	Package Type	IC Marking
ATWILC3000-MU-T	6x6 QFN in Tape and Reel	ATWILC3000

2   Block Diagram

Figure 2-1.   ATWILC3000 Block Diagram
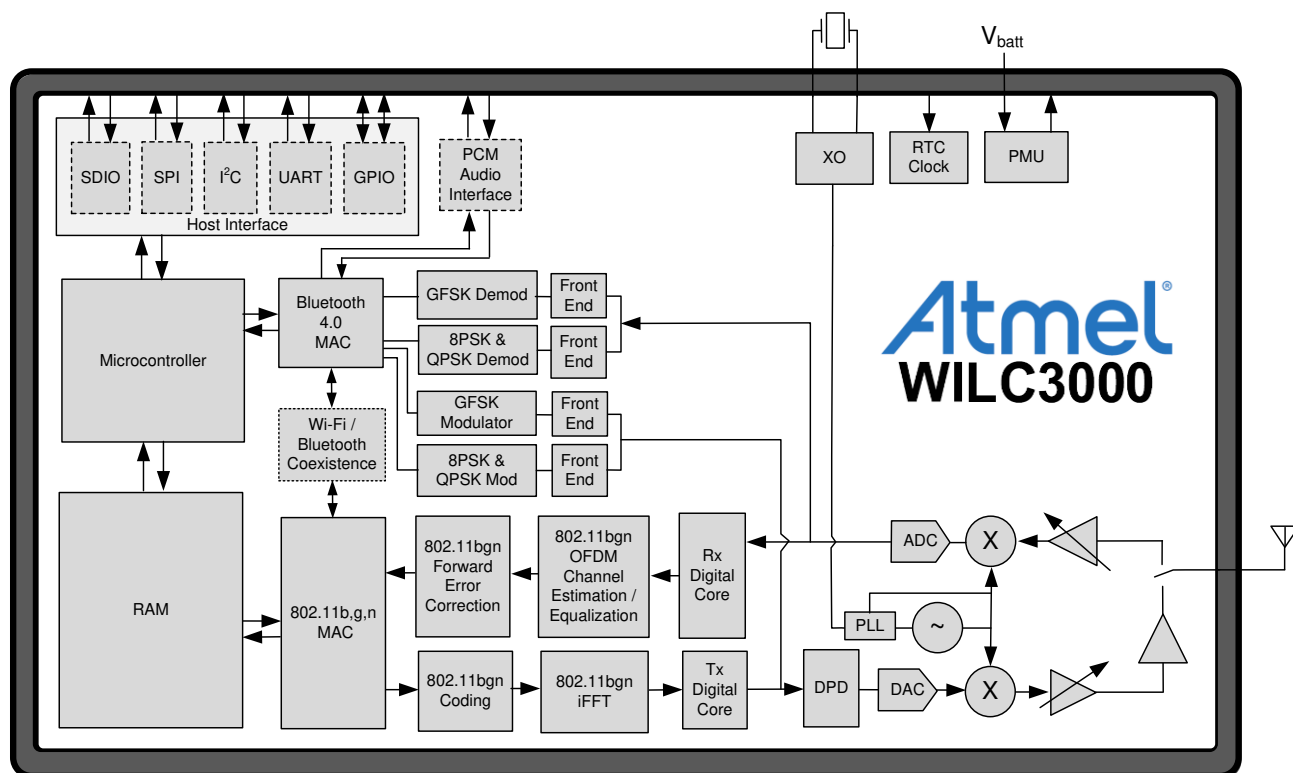
3 Pinout and Package Information

3.1 Pin Description

ATWILC3000 is offered in an exposed pad 48-pin QFN package. This package has an exposed paddle that must be connected to the system board ground. The QFN package pin assignment is shown in Figure 3-1. The color shading is used to indicate the pin type as follows:

- Green – power
- Red – analog
- Blue – digital I/O
- Yellow – digital input
- Grey – unconnected or reserved

The ATWILC3000 pins are described in Table 3-1.

Figure 3-1.   Pin Assignment

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Table 3-1. Pin Description

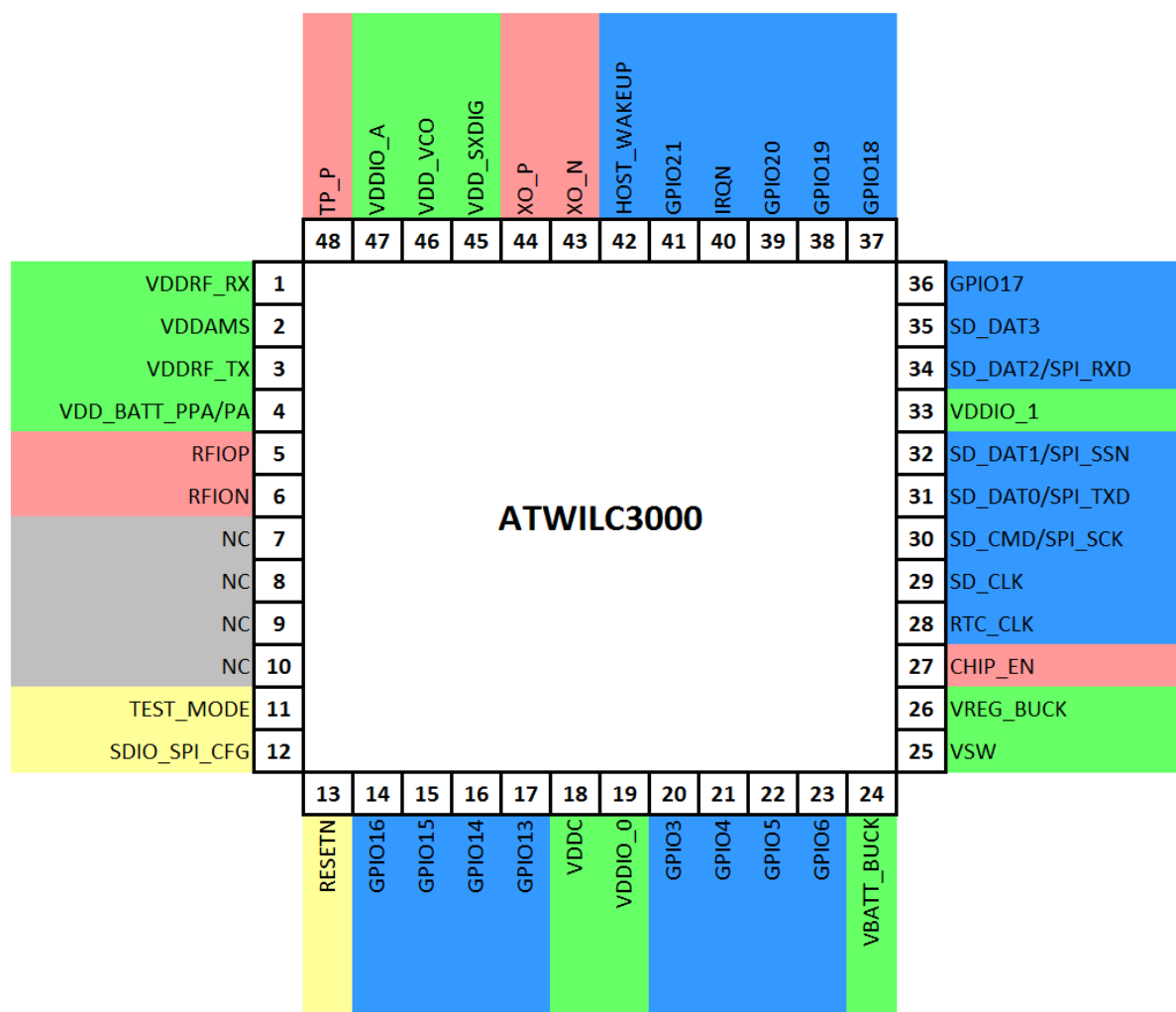| Pin #	Pin Name	Pin Type	Description
1	VDDRF_RX	Power	Tuner RF RX Supply
2	VDDAMS	Power	Tuner BB Supply
3	VDDRF_TX	Power	Tuner RF TX Supply
4	VDDBATT_PPA/PA	Power	Battery Supply for PA
5	RFIOP	Analog	Wi-Fi/Bluetooth Positive RF Differential I/O
6	RFION	Analog	Wi-Fi/Bluetooth Negative RF Differential I/O
7	NC	None	Customer No Connect
8	NC	None	Customer No Connect
9	NC	None	Customer No Connect
10	NC	None	Customer No Connect
11	TEST_MODE	Digital Input	Test Mode – Customer Tie to GND
12	SDIO_SPI_CFG	Digital Input	Tie to VDDIO for SPI, GND for SDIO
13	RESETN	Digital Input	Active-Low Hard Reset
14	GPIO16	Digital I/O, Programmable Pull-Up	GPIO_16/Bluetooth UART Transmit Data Output
15	GPIO15	Digital I/O, Programmable Pull-Up	GPIO_15/Bluetooth UART Receive Data Input
16	GPIO14	Digital I/O, Programmable Pull-Up	GPIO_14/Bluetooth UART RTS output/I^2C Slave Data
17	GPIO13	Digital I/O, Programmable Pull-Up	GPIO_13/Bluetooth UART CTS Input/I^2C Slave Clock/Wi-Fi UART TXD Output
18	VDDC	Power	Digital Core Power Supply
19	VDDIO_0	Power	Digital I/O Power Supply
20	GPIO3	Digital I/O, Programmable Pull-Up	GPIO_3/SPI Flash Clock Output
21	GPIO4	Digital I/O, Programmable Pull-Up	GPIO_4/SPI Flash SSN Output
22	GPIO5	Digital I/O, Programmable Pull-Up	GPIO_5/Wi-Fi UART TXD Output/SPI Flash TX Output (MOSI)
23	GPIO6	Digital I/O, Programmable Pull-Up	GPIO_6/Wi-Fi UART RXD Input/SPI Flash RX Input (MISO)
24	VBATT_BUCK	Power	Battery Supply for DC/DC Converter
25	VSW	Power	Switching Output of DC/DC Converter
26	VREG_BUCK	Power	Core Power from DC/DC Converter
27	CHIP_EN	Analog	PMU Enable
28	RTC_CLK	Digital I/O, Programmable Pull-Up	RTC Clock Input/GPIO_1/Wi-Fi UART RXD Input/Wi-Fi UART TXD Output/BT UART CTS Input
29	SD_CLK	Digital I/O, Programmable Pull-Up	SDIO Clock/GPIO_8/Wi-Fi UART RXD Input/BT UART CTS Input

Pin #	Pin Name	Pin Type	Description
30	SD_CMD/SPI_SCK	Digital I/O, Programmable Pull-Up	SDIO Command/SPI Clock
31	SD_DAT0/SPI_TXD	Digital I/O, Programmable Pull-Up	SDIO Data0/SPI TX Data
32	SD_DAT1/SPI_SSN	Digital I/O, Programmable Pull-Up	SDIO Data1/SPI Slave Select
33	VDDIO_1	Power	Digital I/O Power Supply
34	SD_DAT2/SPI_RXD	Digital I/O, Programmable Pull-Up	SDIO Data2/SPI RX Data
35	SD_DAT3	Digital I/O, Programmable Pull-Up	SDIO Data3/GPIO_7/Wi-Fi UART TXD output/BT UART RTS Output
36	GPIO17	Digital I/O, Programmable Pull-Down	GPIO_17/Bluetooth PCM CLOCK
37	GPIO18	Digital I/O, Programmable Pull-Down	GPIO_18/Bluetooth PCM SNYC
38	GPIO19	Digital I/O, Programmable Pull-Down	GPIO_19/Bluetooth PCM Data Input
39	GPIO20	Digital I/O, Programmable Pull-Down	GPIO_20/Bluetooth PCM Data Output
40	IRQN	Digital I/O, Programmable Pull-Up	Host Interrupt Request Output/Wi-Fi UART RXD Input/BT UART RTS Output
41	GPIO21	Digital I/O, Programmable Pull-Up	GPIO_21/RTC Clock/Wi-Fi UART RXD Input/Wi-Fi UART TXD Output/BT UART RTS Output
42	HOST_WAKEUP	Digital I/O, Programmable Pull-Up	SLEEP Mode Control/Wi-Fi UART TXD output
43	XO_N	Analog	Crystal Oscillator N
44	XO_P	Analog	Crystal Oscillator P
45	VDD_SXDIG	Power	SX Power Supply
46	VDD_VCO	Power	VCO Power Supply
47	VDDIO_A	Power	Tuner VDDIO Power Supply
48	TP_P	Analog	Test Pin/Customer No Connect
49	PADDLE VSS	Power	Connect to System Board Ground

3.2   Package Description

The ATWILC3000 QFN package information is provided in Table 3-2.

Table 3-2.   QFN Package Information

Parameter	Value	Unit	Tolerance
Package Size	5x5	mm	±0.1mm
QFN Pad Count	48		
Total Thickness	0.85	mm	+0.15/-0.05mm
QFN Pad Pitch	0.40		
Pad Width	0.25		
Exposed Pad Size	3.85x3.85		

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The ATWILC3000 40L QFN package view is shown in Figure 3-2.

Figure 3-2.   QFN Package
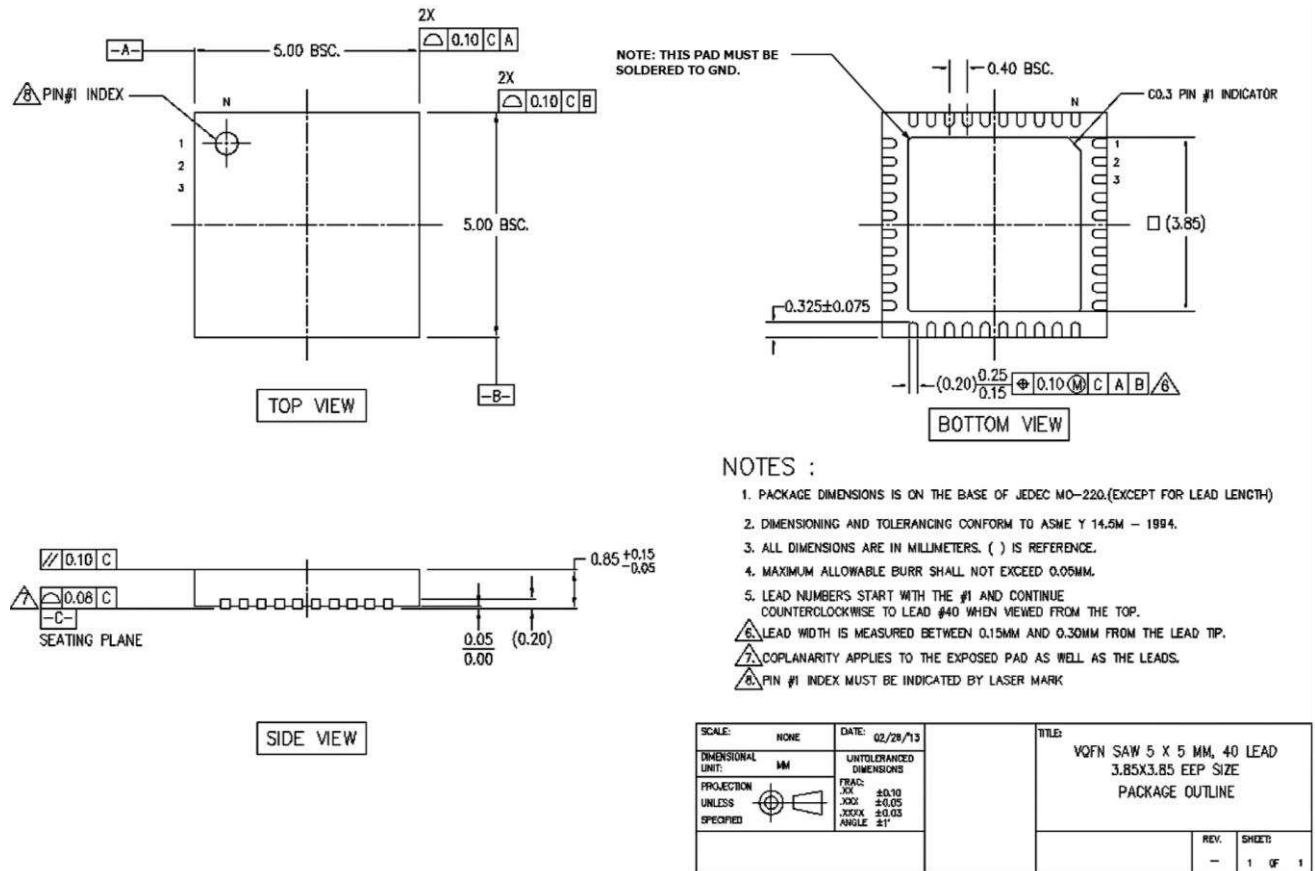
The QFN package is a qualified Green Package.

4 Electrical Specifications

4.1 Absolute Ratings

Table 4-1.   Absolute Maximum Ratings

Characteristic	Symbol	Min.	Max.	Unit
Core Supply Voltage	VDDC	-0.3	1.5	V
I/O Supply Voltage	VDDIO	-0.3	5.0	
Battery Supply Voltage	VBATT	-0.3	5.0	
Digital Input Voltage	V_{IN} [1]	-0.3	VDDIO	
Analog Input Voltage	V_{AIN} [2]	-0.3	1.5	
ESD Human Body Model	V_{ESDHBM}	-1000, -2000 (see notes below)	+1000, +2000 (see notes below)	
Storage Temperature	T_A	-65	150	ºC
Junction Temperature			125	
RF input power max.			23	dBm

Notes: 1. V_{IN} corresponds to all the digital pins.
2. V_{AIN} corresponds to the following analog pins: VDD_RF_RX, VDD_RF_TX, VDD_AMS, RFIOP, RFION, XO_N, XO_P, VDD_SXDIG, and VDD_VCO.
3. For V_{ESDHBM}, each pin is classified as Class 1, or Class 2, or both:
   - The Class 1 pins include all the pins (both analog and digital)
   - The Class 2 pins are all digital pins only
   - V_{ESDHBM} is ±1kV for Class1 pins. V_{ESDHBM} is ±2kV for Class2 pins

4.2 Recommended Operating Conditions

Table 4-2.   Recommended Operating Conditions

Characteristic	Symbol	Min.	Typ.	Max.	Unit
I/O Supply Voltage Low Range	$VDDIO_L$	1.62	1.80	2.00	V
I/O Supply Voltage Mid-Range	$VDDIO_M$	2.00	2.50	3.00	
I/O Supply Voltage High Range	$VDDIO_H$	3.00	3.30	3.60	
Battery Supply Voltage	VBATT	2.5 [1]	3.6	4.2	
Operating Temperature		-40		85	ºC

Notes: 1. ATWILC3000 is functional across this range of voltages; however, optimal RF performance is guaranteed for VBAT in the range 3.0V < VBAT < 4.2V.
2. I/O supply voltage is applied to the following pins: VDDIO_A, VDDIO.
3. Battery supply voltage is applied to following pins: VDD_BATT_PPA, VDD_BATT_PA, and VBATT_BUCK.

4.3 DC Electrical Characteristics

Table 4-3 provides the DC characteristics for the ATWILC3000 digital pads.

Table 4-3. DC Electrical Characteristics

VDDIO Condition	Characteristic	Min.		Max.	Unit
VDDIO$_L$	Input Low Voltage V$_{IL}$	-0.30		0.60	V
	Input High Voltage V$_{IH}$	VDDIO-0.60		VDDIO+0.30	
	Output Low Voltage V$_{OL}$			0.45	
	Output High Voltage V$_{OH}$	VDDIO-0.50			
VDDIO$_M$	Input Low Voltage V$_{IL}$	-0.30		0.63	
	Input High Voltage V$_{IH}$	VDDIO-0.60		VDDIO+0.30	
	Output Low Voltage V$_{OL}$			0.45	
	Output High Voltage V$_{OH}$	VDDIO-0.50			
VDDIO$_H$	Input Low Voltage V$_{IL}$	-0.30		0.65	
	Input High Voltage V$_{IH}$	VDDIO-0.60		VDDIO+0.30 (up to 3.60)	
	Output Low Voltage V$_{OL}$			0.45	
	Output High Voltage V$_{OH}$	VDDIO-0.50			
All	Output Loading			20	pF
All	Digital Input Load			6	
VDDIO$_L$	Pad Drive Strength	1.7	2.4		mA
VDDIO$_M$	Pad Drive Strength	3.4	6.5		
VDDIO$_H$	Pad Drive Strength	10.6	13.5		

5 Clocking

5.1 Crystal Oscillator

Table 5-1. Crystal Oscillator Parameters

Parameter	Min.	Typ.	Max.	Unit
Crystal Resonant Frequency	14	26	40	MHz
Crystal Equivalent Series Resistance		50	150	Ω
Stability – Initial Offset [1]	-100		100	ppm
Stability - Temperature and Aging	-20		20	

Note: 1.   Initial offset must be calibrated to maintain ±20ppm in all operating conditions when including temperature and aging. This calibration is performed during final production testing.

The block diagram in Figure 5-1(a) shows how the internal Crystal Oscillator (XO) is connected to the external crystal. The XO has 5pF internal capacitance on each terminal XO_P and XO_N. To bypass the crystal oscillator with an external reference, an external signal capable of driving 5pF can be applied to the XO_N terminal as shown in Figure 5-1(b).

Figure 5-1. XO Connections

(a)   (b)

(a) Crystal Oscillator is used   (b) Crystal Oscillator is bypassed
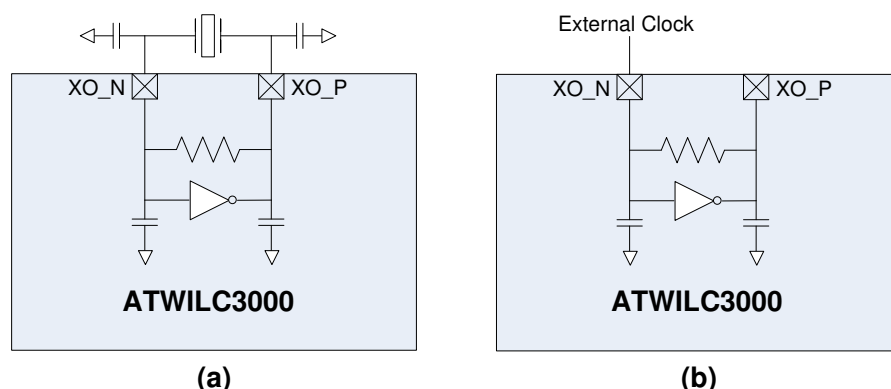
Below are the electrical and performance requirements for the external clock.

Table 5-2. Bypass Clock Specification

Parameter	Min.	Max.	Unit	Comments
Oscillation frequency	12	40	MHz	Must be able to drive 5pF load @ desired frequency
Voltage swing	0.5	1.2	V_{pp}	Must be AC coupled
Stability – Temperature and Aging	-20	+20	ppm	
Phase Noise		-130	dBc/Hz	At 10kHz offset
Jitter(RMS)		<1psec		Based on integrated phase noise spectrum from 1kHz to 1MHz

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5.2 Low-Power Oscillator

ATWILC3000 requires an external 32.768kHz clock to be used for sleep operation, which is provided through Pin 28 or Pin 41. The frequency accuracy of the external clock has to be within ±500ppm.

6 CPU and Memory Subsystems

6.1 Processor

ATWILC3000 has a Cortus APS3 32-bit processor. This processor performs many of the MAC functions, including but not limited to association, authentication, power management, security key management, and MSDU aggregation/de-aggregation. In addition, the processor provides flexibility for various modes of operation, such as STA and AP modes.

6.2 Memory Subsystem

The APS3 core uses a 256kB instruction/boot ROM (160kB for 802.11 and 96kB for Bluetooth) along with a 420kB instruction RAM (128kB for 802.11 and 292kB for Bluetooth), and a 128kB data RAM (64kB for 802.11 and 64kB for Bluetooth). In addition, the device uses a 160kB shared/exchange RAM (128kB for 802.11 and 32kB for Bluetooth), accessible by the processor and MAC, which allows the processor to perform various data management tasks on the TX and RX data packets.

6.3 Non-Volatile Memory (eFuse)

ATWILC3000 has 768 bits of non-volatile eFuse memory that can be read by the CPU after device reset. This non-volatile one-time-programmable memory can be used to store customer-specific parameters, such as 802.11 MAC address, Bluetooth address, and various calibration information, such as TX power, crystal frequency offset, etc., as well as other software-specific configuration parameters. The eFuse is partitioned into six 128-bit banks. The bit map of the first and last banks is shown in Figure 6-1. The purpose of the first 80 bits in bank 0 and the first 56 bits in bank 5 is fixed, and the remaining bits are general-purpose software dependent bits, or reserved for future use. Currently the Bluetooth address is derived from the Wi-Fi MAC address (BT_ADDR=MAC_ADDR+1). This eliminates the need to program the first 56 bits in bank 5. Since each bank and each bit can be programmed independently, this allows for several updates of the device parameters following the initial programming, e.g. updating 802.11 MAC address or Bluetooth address (this can be done by invalidating the last programmed bank and programming a new bank). Refer to ATWILC3000 Programming Guide for the eFuse programming instructions.

Figure 6-1.   eFuse Bit Map
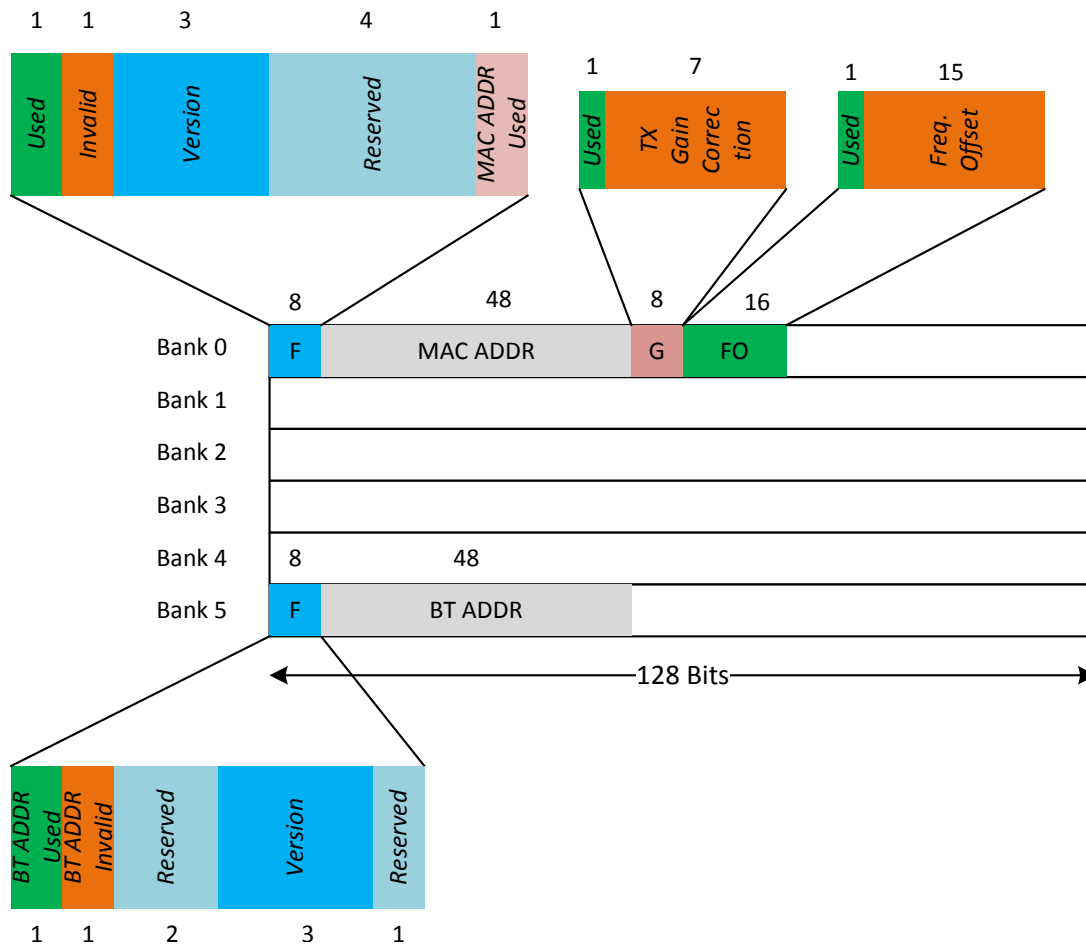
7 WLAN Subsystem

The WLAN subsystem is composed of the Media Access Controller (MAC) and the Physical Layer (PHY). Sections 7.1 and 7.2 describe the MAC and PHY in detail.

7.1 MAC

7.1.1 Features

The ATWILC3000 IEEE802.11 MAC supports the following functions:

- IEEE 802.11b/g/n
- IEEE 802.11e WMM QoS EDCA/PCF multiple access categories traffic scheduling
- Advanced IEEE 802.11n features:
    - Transmission and reception of aggregated MPDUs (A-MPDU)
    - Transmission and reception of aggregated MSDUs (A-MSDU)
    - Immediate Block Acknowledgement
    - Reduced Interframe Spacing (RIFS)
- Support for IEEE802.11i and WFA security with key management
    - WEP 64/128
    - WPA-TKIP
    - 128-bit WPA2 CCMP (AES)
- Support for WAPI security
- Advanced power management
    - Standard 802.11 Power Save Mode
    - Wi-Fi Alliance WMM-PS (U-APSD)
- RTS-CTS and CTS-self support
- Supports either STA or AP mode in the infrastructure basic service set mode
- Supports independent basic service set (IBSS)

7.1.2 Description

The ATWILC3000 MAC is designed to operate at low power while providing high data throughput. The IEEE 802.11 MAC functions are implemented with a combination of dedicated data path engines, hardwired control logic, and a low-power, high-efficiency microprocessor. The combination of dedicated logic with a programmable processor provides optimal power efficiency and real-time response while providing the flexibility to accommodate evolving standards and future feature enhancements.

Dedicated data path engines are used to implement data path functions with heavy computational requirements. For example, an FCS engine checks the CRC of the transmitting and receiving packets, and a cipher engine performs all the required encryption and decryption operations for the WEP, WPA-TKIP, WPA2 CCMP-AES, and WAPI security requirements.

Control functions, which have real-time requirements, are implemented using hardwired control logic modules. These logic modules offer real-time response while maintaining configurability via the processor. Examples of hardwired control logic modules are the channel access control module (implements EDCA/HCCA, Beacon TX control, interframe spacing, etc.), protocol timer module (responsible for the Network Access Vector, back-off timing, timing synchronization function, and slot management), MPDU handling module, aggregation/de-aggregation module, block ACK controller (implements the protocol requirements for burst block communication), and TX/RX control FSMs (coordinate data movement between PHY-MAC interface, cipher engine, and the DMA interface to the TX/RX FIFOs).

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The MAC functions implemented solely in software on the microprocessor have the following characteristics:

- Functions with high memory requirements or complex data structures. Examples are association table management and power save queuing.
- Functions with low computational load or without critical real-time requirements. Examples are authentication and association.
- Functions, which need flexibility and upgradeability. Examples are beacon frame processing and QoS scheduling.

7.2 PHY

7.2.1 Features

The ATWILC3000 IEEE802.11 PHY supports the following functions:

- Single antenna 1x1 stream in 20MHz channels
- Supports IEEE 802.11b DSSS-CCK modulation: 1, 2, 5.5, and 11Mbps
- Supports IEEE 802.11g OFDM modulation: 6, 9, 12,18, 24, 36, 48, and 54Mbps
- Supports IEEE 802.11n HT modulations MCS0-7, 20MHz, 800 and 400ns guard interval: 6.5, 7.2, 13.0, 14.4, 19.5, 21.7, 26.0, 28.9, 39.0, 43.3, 52.0, 57.8, 58.5, 65.0, and 72.2Mbps
- IEEE 802.11n mixed mode operation
- Per packet TX power control
- Advanced channel estimation/equalization, automatic gain control, CCA, carrier/symbol recovery, and frame detection

7.2.2 Description

The ATWILC3000 WLAN PHY is designed to achieve reliable and power-efficient physical layer communication specified by IEEE 802.11b/g/n in single stream mode with 20MHz bandwidth. Advanced algorithms have been employed to achieve maximum throughput in a real world communication environment with impairments and interference. The PHY implements all the required functions such as FFT, filtering, FEC (Viterbi decoder), frequency, and timing acquisition and tracking, channel estimation and equalization, carrier sensing and clear channel assessment, as well as the automatic gain control.

7.3 802.11 b/g/n Radio Performance

7.3.1 Receiver Performance

Radio performance under typical conditions: VBATT=3.6V; VDDIO=3.3V; temp.: 25°C.

Table 7-1.   ATWILC3000 Conducted Receiver Performance

Parameter	Description	Min.	Typ.	Max.	Unit
Frequency		2,412		2,484	MHz
Sensitivity 802.11b	1Mbps DSS		-98.0		dBm
	2Mbps DSS		-95.0		
	5.5Mbps DSS		-93.0		
	11Mbps DSS		-89.0		
Sensitivity 802.11g	6Mbps OFDM		-90.6		dBm
	9Mbps OFDM		-89.0		
	12Mbps OFDM		-87.9		

Parameter	Description	Min.	Typ.	Max.	Unit
	18Mbps OFDM		-86.0		dBm
	24Mbps OFDM		-83.0		
	36Mbps OFDM		-79.8		
	48Mbps OFDM		-76.0		
	54Mbps OFDM		-74.3		
Sensitivity 802.11n (BW=20MHz)	MCS 0		-89.0		dBm
	MCS 1		-86.9		
	MCS 2		-84.9		
	MCS 3		-82.4		
	MCS 4		-79.2		
	MCS 5		-75.0		
	MCS 6		-73.2		
	MCS 7		-71.2		
Maximum Receive Signal Level	1-11Mbps DSS	-10	5		dBm
	6-54Mbps OFDM	-10	-3		
	MCS 0 – 7	-10	-3		
Adjacent Channel Rejection	1Mbps DSS (30MHz offset)		50		dB
	11Mbps DSS (25MHz offset)		43		
	6Mbps OFDM (25MHz offset)		40		
	54Mbps OFDM (25MHz offset)		25		
	MCS 0 – 20MHz BW (25MHz offset)		40		
	MCS 7 – 20MHz BW (25MHz offset)		20		

7.3.2 Transmitter Performance

Radio Performance under typical conditions: VBATT=3.6V; VDDIO=3.3V; temp.: 25°C.

Table 7-2. Transmitter Performance

Parameter	Description	Min.	Typ.	Max.	Unit
Frequency		2,412		2,484	MHz
Output Power	802.11b DSSS 1Mbps		19^1		dBm
	802.11b DSSS 11Mbps		17^1		
	802.11g OFDM 54Mbps		16^1		
	802.11n MCS7		14^1		
TX Power Accuracy			$\pm1.5^2$		dB
Carrier Suppression			30.0		dBc

Notes: 1. Measured at 802.11 spec compliant EVM/Spectral Mask.
2. Measured with 50Ω differential balun.

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8 Bluetooth Subsystem

The Bluetooth subsystem implements all the mission critical real-time functions. It encodes/decodes HCI packets, constructs baseband data packages, and manages and monitors connection status, slot usage, data flow, routing, segmentation, and buffer control. The Bluetooth subsystem supports both conventional Bluetooth as well as Bluetooth Low Energy (BLE) modes of operation.

The Bluetooth Subsystem performs Link Control Layer management supporting the following states:

- Standby
- Connection
- Page and Page Scan
- Inquiry and Inquiry Scan
- Sniff

8.1 Bluetooth 4.0

Features:

- Extended Inquiry Response (EIR)
- Encryption Pause/Resume (EPR)
- Sniff Sub-Rating (SSR)
- Secure Simple Pairing (SSP)
- Link Supervision Time Out (LSTO)
- Link Management Protocol (LMP)
- Quality of Service (QOS)

8.2 Bluetooth Low Energy (BLE)

Supports BLE profiles allowing connection to advanced low energy application such as:

- Smart Energy
- Consumer Wellness
- Home Automation
- Security
- Proximity Detection
- Entertainment
- Sports and Fitness
- Automotive

8.3 Bluetooth Radio

8.3.1 Receiver Performance

Radio Performance under typical conditions: VBATT=3.6V; VDDIO=3.3V; temp.: 25°C.

Table 8-1.   ATWILC3000 Bluetooth Receiver Performance

Parameter	Description	Min.	Typ.	Max.	Unit
Frequency			2,402		2,480	MHz
Sensitivity Ideal TX	GFSK (0.1% BER) 1Mbps		-93.0		dBm
	π/4 DQPSK (0.1% BER) 2Mbps		-95.6		
	8DPSK (0.1% BER) 3Mbps		-90.0		
	BLE (GFSK)		-96		
Maximum Receive Signal Level	GFSK	-10	0		dBm
	π/4 DQPSK	-10	-5		
	8DPSK	-10	-5		

8.3.2 Transmitter Performance

Radio Performance under typical conditions: VBATT=3.6V; VDDIO=3.3V; temp.: 25°C.

Table 8-2.   ATWILC3000 Bluetooth Transmitter Performance

Parameter	Description	Min.	Typ.	Max.	Unit
Frequency		2,402		2,480	MHz
Output Power	GFSK	-32	10.0	17[1]	dBm
	π/4 DQPSK	-32	10.0	17[1]	
	8DPSK	-32	10.0	17[1]	
	BLE (GFSK)	-32	10.0	17[1]	

Note: 1.   The maximum output power may require board filtering to meet spurious emission limits.

9 External Interfaces

ATWILC3000 external interfaces include: SPI Slave, SDIO Slave, and UART for 802.11 control and data transfer; UART for Bluetooth control and data transfer, and audio; PCM for Bluetooth audio; I^{2}C Slave for control; SPI Master for external Flash; I^{2}C Master for external EEPROM, and General Purpose Input / Output (GPIO) pins. With the exception of the SPI Slave and SDIO Slave host interfaces, which are selected using the dedicated SDIO_SPI_CFG pin, the other interfaces can be assigned to various pins by programming the corresponding pin muxing control register for each pin to a specific value between 0 and 6. The default values of these registers are 0, which is GPIO mode. Each digital I/O pin also has a programmable pull-up or pull-down. The summary of the available interfaces and their corresponding pin MUX settings is shown in Table 9-1. For specific programming instructions refer to ATWILC3000 Programming Guide.

Table 9-1.   Pin-MUX Matrix of External Interfaces

Pin Name	Pin #	Pull	MUX0	MUX1	MUX2	MUX3	MUX4	MUX5	MUX6
GPIO16	14	Up	GPIO_16	O_BT_UART1_TXD					
GPIO15	15	Up	GPIO_15	I_BT_UART1_RXD					
GPIO14	16	Up	GPIO_14	O_BT_UART1_RTS	IO_I2C_SDA				I_WAKEUP
GPIO13	17	Up	GPIO_13	I_BT_UART1_CTS	IO_I2C_SCL	O_WIFI_UART_TXD			I_WAKEUP
GPIO3	20	Up	GPIO_3	O_SPI_SCK_FLASH					O_BT_UART2_TXD
GPIO4	21	Up	GPIO_4	O_SPI_SSN_FLASH					I_BT_UART2_RXD
GPIO5	22	Up	GPIO_5	O_SPI_TXD_FLASH		O_WIFI_UART_TXD			I_WAKEUP
GPIO6	23	Up	GPIO_6	I_SPI_RXD_FLASH		I_WIFI_UART_RXD			I_WAKEUP
RTC_CLK	28	Up	GPIO_1	I_RTC_CLK		I_WIFI_UART_RXD	O_WIFI_UART_TXD	I_BT_UART1_CTS	
SD_CLK	29	Up	GPIO_8	I_SD_CLK		I_WIFI_UART_RXD	I_BT_UART1_CTS		
SD_CMD/SPI_SCK	30	Up		IO_SD_CMD	IO_SPI_SCK				
SD_DAT0/SPI_TXD	31	Up		IO_SD_DAT0	O_SPI_TXD				
SD_DAT1/SPI_SSN	32	Up		IO_SD_DAT1	IO_SPI_SSN				
SD_DAT2/SPI_RXD	34	Up		IO_SD_DAT2	I_SPI_RXD				
SD_DAT3	35	Up	GPIO_7	IO_SD_DAT3		O_WIFI_UART_TXD	O_BT_UART1_RTS		
GPIO17	36	Down	GPIO_17	IO_BT_PCM_CLK					I_WAKEUP
GPIO18	37	Down	GPIO_18	IO_BT_PCM_SYNC					I_WAKEUP
GPIO19	38	Down	GPIO_19	I_BT_PCM_D_IN					I_WAKEUP
GPIO20	39	Down	GPIO_20	O_BT_PCM_D_OUT					I_WAKEUP
IRQN	40	Up	GPIO_2	O_IRQN		I_WIFI_UART_RXD	O_BT_UART1_RTS		
GPIO21	41	Up	GPIO_21	I_RTC_CLK		I_WIFI_UART_RXD	O_WIFI_UART_TXD	O_BT_UART1_RTS	IO_I2C_MASTER_SCL
HOST_WAKEUP	42	Up	GPIO_0	I_WAKEUP		O_WIFI_UART_TXD			IO_I2C_MASTER_SDA

9.1   I^{2}C Slave Interface

The I^{2}C Slave interface, used primarily for control by the host processor, is a two-wire serial interface consisting of a serial data line (SDA) on Pin 16 (GPIO14) and a serial clock line (SCL) on Pin 17 (GPIO13). I^{2}C Slave responds to the seven bit address value 0x60. The ATWILC3000 I^{2}C supports I^{2}C bus Version 2.1 - 2000 and can operate in standard mode (with data rates up to 100Kb/s) and fast mode (with data rates up to 400Kb/s).

The I^{2}C Slave is a synchronous serial interface. The SDA line is a bidirectional signal and changes only while the SCL line is low, except for STOP, START, and RESTART conditions. The output drivers are open-drain to perform wire-AND functions on the bus. The maximum number of devices on the bus is limited by only the maximum capacitance specification of 400pF. Data is transmitted in byte packages.

For specific information, refer to the Philips Specification entitled "The I^{2}C -Bus Specification, Version 2.1".
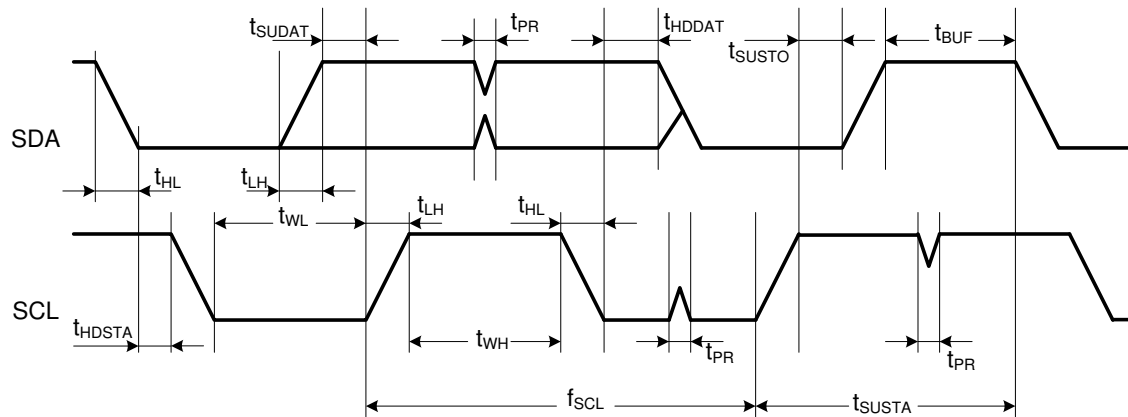
Figure 9-2. I²C Slave Timing Diagram

Table 9-2. I²C Slave Timing Parameters

Parameter	Symbol	Min.	Max.	Unit	Remarks
SCL Clock Frequency	f_{SCL}	0	400	kHz	
SCL Low Pulse Width	t_{WL}	1.3		µs	
SCL High Pulse Width	t_{WH}	0.6			
SCL, SDA Fall Time	t_{HL}		300	ns	
SCL, SDA Rise Time	t_{LH}		300		This is dictated by external components
START Setup Time	t_{SUSTA}	0.6		µs	
START Hold Time	t_{HDSTA}	0.6			
SDA Setup Time	t_{SUDAT}	100		ns	
SDA Hold Time	t_{HDDAT}	0 40			Slave and Master Default Master Programming Option
STOP Setup time	t_{SUSTO}	0.6		µs	
Bus Free Time Between STOP and START	t_{BUF}	1.3			
Glitch Pulse Reject	t_{PR}	0	50	ns	

9.2 I²C Master Interface

ATWILC3000 provides an I²C bus master, which is intended primarily for accessing an external EEPROM memory through a software-defined protocol. The I²C Master is a two-wire serial interface consisting of a serial data line (SDA) and a serial clock line (SCL). SDA can be configured on pin 42 (HOST_WAKEUP), and SCL can be configured on pin 41 (GPIO21).

The I²C Master interface supports three speeds:

- Standard mode (100kb/s)
- Fast mode (400kb/s)
- High-speed mode (3.4Mb/s)

The timing diagram of the I²C Master interface is the same as that of the I²C Slave interface (see Section 9.3). The timing parameters of I²C Master are shown in Table 9-3.

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Table 9-3. I²C Master Timing Parameters

Parameter	Symbol	Standard Mode		Fast Mode		High-Speed Mode		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
SCL Clock Frequency	f_{SCL}	0	100	0	400	0	3400	kHz
SCL Low Pulse Width	t_{WL}	4.7		1.3		0.16		μs
SCL High Pulse Width	t_{WH}	4		0.6		0.06		
SCL Fall Time	t_{HLSCL}		300		300	10	40	ns
SDA Fall Time	t_{HLSDA}		300		300	10	80	
SCL Rise Time	t_{LHSCL}		1000		300	10	40	
SDA Rise Time	t_{LHSDA}		1000		300	10	80	
START Setup Time	t_{SUSTA}	4.7		0.6		0.16		μs
START Hold Time	t_{HDSTA}	4		0.6		0.16		
SDA Setup Time	t_{SUDAT}	250		100		10		ns
SDA Hold Time	t_{HDDAT}	5		40		0	70	
STOP Setup time	t_{SUSTO}	4		0.6		0.16		μs
Bus Free Time Between STOP and START	t_{BUF}	4.7		1.3				
Glitch Pulse Reject	t_{PR}			0	50			

9.3 SPI Slave Interface

ATWILC3000 provides a Serial Peripheral Interface (SPI) that operates as a SPI slave. The SPI Slave interface can be used for control and for serial I/O of 802.11 data. The SPI Slave pins are mapped as shown in Table 9-4. The RXD pin is same as Master Output, Slave Input (MOSI), and the TXD pin is same as Master Input, Slave Output (MISO). The SPI Slave is a full-duplex slave-synchronous serial interface that is available immediately following reset when Pin 12 (SDIO_SPI_CFG) is tied to VDDIO.

Table 9-4. SPI Slave Interface Pin Mapping

Pin #	SPI Function
12	CFG: Must be tied to VDDIO
32	SSN: Active Low Slave Select
30	SCK: Serial Clock
34	RXD: Serial Data Receive (MOSI)
31	TXD: Serial Data Transmit (MISO)

When the SPI is not selected, i.e., when SSN is high, the SPI interface will not interfere with data transfers between the serial-master and other serial-slave devices. When the serial slave is not selected, its transmitted data output is buffered, resulting in a high impedance drive onto the serial master receive line.
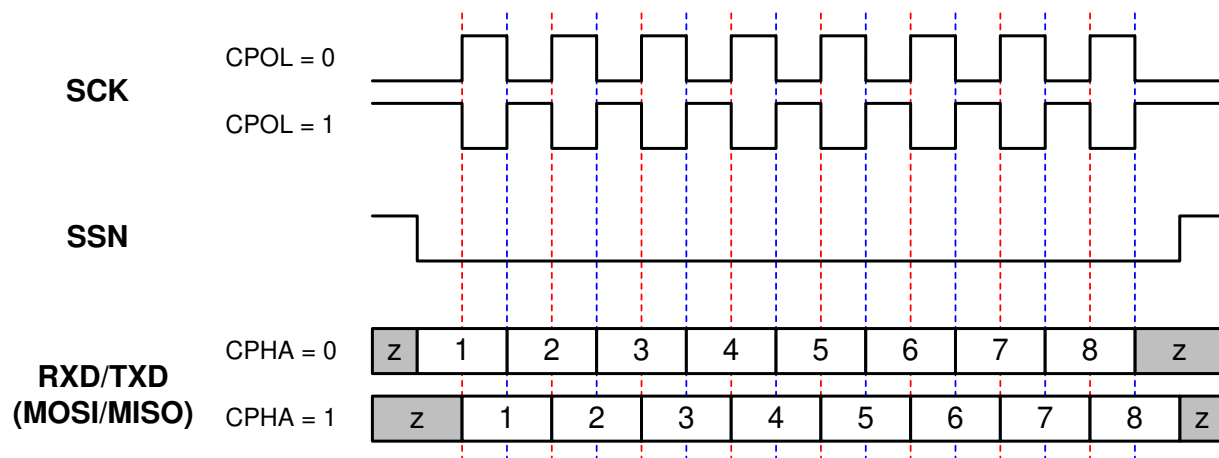
The SPI Slave interface responds to a protocol that allows an external host to read or write any register in the chip as well as initiate DMA transfers. For the details of the SPI protocol and more specific instructions refer to ATWILC3000 Programming Guide.

The SPI Slave interface supports four standard modes as determined by the Clock Polarity (CPOL) and Clock Phase (CPHA) settings. These modes are illustrated in Table 9-5. The red lines in diagram correspond to Clock Phase = 0 and the blue lines correspond to Clock Phase = 1.

Table 9-5.   SPI Slave Modes

Mode	CPOL	CPHA
0	0	0
1	0	1
2	1	0
3	1	1

Figure 9-3.   SPI Slave Clock Polarity and Clock Phase Timing

The SPI Slave timing is provided in Figure 9-4.

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Figure 9-4.   SPI Slave Timing Diagram
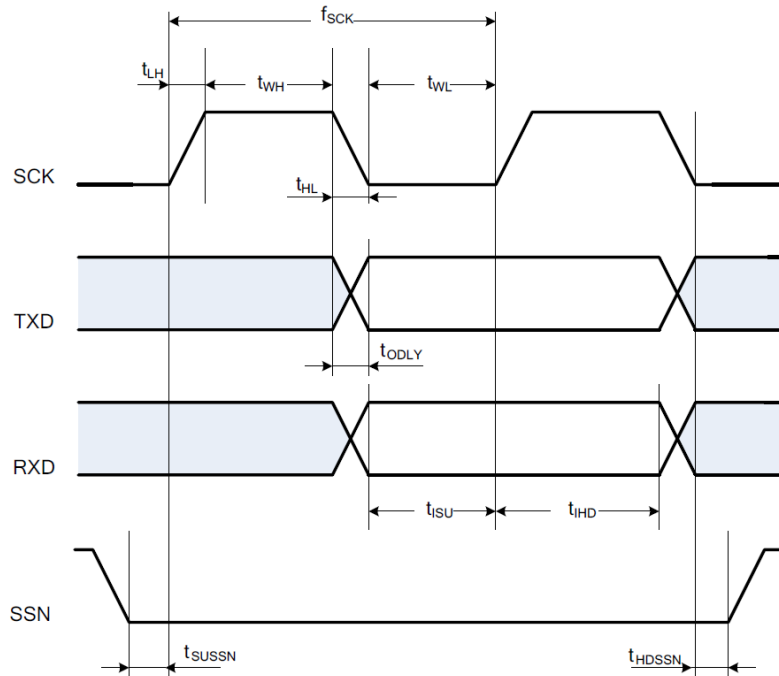
Table 9-6.   SPI Slave Timing Parameters [1]

Parameter	Symbol	Min.	Max.	Unit
Clock Input Frequency [2]	f_{SCK}		48	MHz
Clock Low Pulse Width	t_{WL}	6		ns
Clock High Pulse Width	t_{WH}	4		
Clock Rise Time	t_{LH}	0	7	
Clock Fall Time	t_{HL}	0	7	
TXD Output Delay [3]	t_{ODLY}	3	9 from SCK fall 11 from SCK rise	
RXD Input Setup Time	t_{ISU}	3		
RXD Input Hold Time	t_{IHD}	5		
SSN Input Setup Time	t_{SUSSN}	5		
SSN Input Hold Time	t_{HDSSN}	5		

Notes: 1.   Timing is applicable to all SPI modes.
2.   Maximum clock frequency specified is limited by the SPI Slave interface internal design; actual maximum clock frequency can be lower and depends on the specific PCB layout.
3.   Timing based on 15pF output loading.

9.4   SPI Master Interface

ATWILC3000 provides a SPI Master interface for accessing external Flash memory. The SPI Master pins are mapped as shown in Table 9-7. The TXD pin is same as Master Output, Slave Input (MOSI), and the RXD pin is same as Master Input, Slave Output (MISO). The SPI Master interface supports all four standard modes of clock polarity and clock phase shown below. External SPI Flash memory is accessed by a processor